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Creation of Hollow Silica - Fiberglass Soft Ceramics for Thermal Insulation

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24 **Abstract**

25 Hollow-structured materials show promise in thermal insulation because the shell
26 encapsulating gaseous voids can interrupt heat transport pathways. Here, we
27 present two low-cost routes to fabricate hollow silica nanoshells, via gas-phase and
28 liquid-phase methods. The gas-phase synthesis method generates hollow shells by
29 a droplet surface precipitation mechanism in a flame aerosol reactor. The liquid-
30 phase synthesis route forms hollow shells by removal of a carbon template, which
31 is produced by hydrothermal reaction of glucose. Both approaches (gas- and
32 liquid-phase) provide hollow silica with amorphous structure, low thermal
33 conductivity (0.023 and 0.026 W m⁻¹ K⁻¹), small particle size (442 and 383 nm), thin
34 shell (35 and 36 nm), and low density (0.015 and 0.033 g cm⁻³). We employed high
35 shear mechanical mixing to fabricate hollow silica – fiberglass composite ceramics.
36 The resulting three-dimensional network provides the ceramics with robust
37 mechanical elasticity and fire-retardancy while maintaining the low thermal
38 conductivity, dramatically outperforming an analogous material using commercial
39 silica gel in place of the hollow nanoshells. Our findings provide two practical
40 routes to synthesize hollow silica, either of which can be used to manufacture a
41 class of aerosol-fiber soft ceramics for energy-saving applications.

42

43 **Keywords:** Hollow silica; thermal insulation; aerogel ceramic; fiberglass;
44 mechanical flexibility; energy conservation

45 **Introduction**

46 Thermal energy accounts for a major portion of overall energy consumption in our
47 society. Thus, thermal insulation materials, which limit heat flow, play a significant
48 role in thermal energy storage and conservation.[1] In this context, silica aerogel,
49 which limits thermal by confining air in voids created by the aggregated assembly
50 of silica nanoparticles, provides ultralow thermal conductivity ($\approx 0.013 \text{ W m}^{-1} \text{ K}^{-1}$)
51 and is one of the most effective insulation materials for thermal management.[2,
52 3] However, practical use of silica aerogel is normally limited by its fragile
53 structure and the high cost of its energy-intensive fabrication process involving
54 CO_2 supercritical drying.[4-6] The excellent insulation performance of silica
55 aerogels motivates researches to improve their mechanical properties,[7, 8] lower
56 their production cost,[9, 10] and develop other nanomaterials with similar
57 properties.[11-14] Among them, hollow silica micro/nano-sphere show great
58 promise, due to their low thermal conductivity and density, approaching those of
59 silica aerogels.[15-17]

60

61 The voids in hollow silica, similar to those in silica aerogels, interrupt heat
62 transport pathways in both the solid and gas phases.[15, 16] Several strategies
63 have been developed to introduce a hollow void in silica particles, such as use of a
64 sacrificial template,[18] emulsification,[19] and acid etch methods.[20] These
65 liquid-phase synthesis methods enable flexible design of the particle size, shell
66 thickness, and porosity,[21] but often require multi-step batch operations,
67 resulting in laborious production procedures.[22, 23] In contrast, aerosol
68 processes, *i.e.*, gas-phase continuous nanoparticle synthesis methods, are the
69 most common technologies for large-scale production of inorganic powders in
70 industry.[24, 25] Previous studies reported the fabrication of hollow silica

71 microsphere particles using a spray-drying aerosol process, based on a template-
72 free “droplet-to-particle” conversion.[26-28] In general, the “droplet-to-particle”
73 conversion produces hollow voids by precursor droplet evaporation, which leads to
74 a higher solute concentration at the droplet surface than in its interior. As a result,
75 the product precipitates on the droplet surface and grows toward the center,
76 finally resulting in a hollow structure. However, the relatively mild reaction
77 conditions (low temperature and long residence time) usually result in a large
78 particle size and thick shell,[27, 29] relative to the dimensions desired for thermal
79 insulation applications, where small void size and thin shells are desired.[16] In
80 contrast, flame aerosol processes can form nano-sized silica particles via the “gas-
81 to-particle” conversion but that route does not provide a hollow structure.[30-32]
82 Therefore, a novel gas-phase synthesis method, which combines both advantages
83 of spray-drying and flame aerosol processes, and produces hollow silica particles
84 with small size and thin shell, is highly desirable.[33-36]

85

86 Furthermore, assembly of hollow silica particles into bulk materials is necessary for
87 practical use in thermal insulation. Previous studies demonstrated that the hollow
88 silica particles can be directly assembled into self-supported macroscopic colloidal
89 crystals by thermal annealing[37, 38] or sintered to porous ceramics.[39]
90 However, the physical particle aggregation and narrow solid contacts lead to the
91 brittle and stiff nature of such aerogel ceramics, greatly limiting their applications
92 in dynamic and high energy output environments, such isolation of battery packs
93 subject thermal runaway and fireproofing.[8, 40] Simultaneously, the bonding
94 between silica shells generates solid heat transport pathways and increases the
95 thermal conductivity.[16] Blends of hollow silica particles into a polymer matrix to
96 fabricate thermal insulation films can produce robust mechanical properties,[17,

97 41, 42] but the intrinsic high thermal conductivity and low melting point of
98 polymers constrain the potential of this class of materials. Recently, some
99 technologies have been developed to reinforce aerogel particles with fibers
100 (polymer fiber or fiberglass), such as electrospinning,[43] hot pressing,[44] and 3D
101 printing,[45] which can produce both excellent thermal insulation and mechanical
102 properties. For example, incorporation of hollow silica nanoshells into a matrix of
103 polymer fibers by electrospinning can yield flexible insulation composite
104 membranes with low thermal conductivities of $0.0236 \text{ W m}^{-1} \text{ K}^{-1}$ [46] and 0.016 W m^{-1}
105 K^{-1} . [47] However, despite the outstanding potential, these methods still face
106 barriers for practical use due to limited ability to scale up and high energy inputs
107 per quantity of material produced.

108

109 In this study, we adopt a gas-phase synthesis method based on a modified aerosol
110 reactor to produce hollow silica particles with small size and thin, porous shell
111 following an approach we have previously presented.[48] In addition, we also
112 adopt a liquid-phase synthesis route to produce hollow silica particles, using
113 carbon microspheres prepared from glucose by a hydrothermal reaction, as a
114 sacrificial template.[18] Both as-synthesized hollow silicas exhibit much lower
115 thermal conductivity than commercial silica gel. We also report a facile high-shear
116 mechanical mixing method for the large-scale manufacturing of hollow silica -
117 fiberglass soft ceramic insulation materials, without any expensive devices,
118 energy-consuming procedures, or organic chemicals involved. The resulting soft
119 ceramics show an internal structure of a 3D network between connected hollow
120 silica particles and the fiberglass matrix. The hollow silica particles are reasonably
121 assembled together and uniformly distributed on the fiberglass surface, at the
122 same time, while the fiberglass networks are interfaced and further reinforced with

123 hollow silica. Such a synergistic effect improves the mechanical performance while
124 maintaining the low thermal conductivity of hollow silica. This fabrication strategy
125 allows creation of aerogel-fiber composite soft ceramics for thermal management
126 by a low-cost and environmentally friendly route.

127

128 **Experimental section**

129 **1. Chemicals**

130 Tetraethyl orthosilicate (TEOS, 98%), hexadecyltrimethylammonium bromide
131 (CTAB, 99+%), and hydrochloric acid solution (37% HCl) were obtained from
132 ACROS ORGANICS. Glucose monohydrate ($C_6H_{12}O_6 \cdot H_2O$) was obtained from SIGMA-
133 ALDRICH. Ethanol (200 proof) was obtained from Decon Labs, Inc. Ammonium
134 hydroxide solution (28.0~30.0% NH_3) was obtained from EMD Millipore. The
135 commercial silica gel (C-SiO₂) was obtained from Aldrich Chemical Company
136 (Catalog No. 28,860-8). The commercial fiberglass was obtained from Unifrax
137 (Grade C-08-F).

138

139 **2. Fabrication of hollow silica particles**

140 **2.1 G-SiO₂**

141 The material denoted as G-SiO₂ was produced *via* gas-phase synthesis route in a
142 modified flame aerosol reactor (**Figure S1**). The H₂-rich flame was produced using
143 flows of 17 L/min H₂, 4 L/min O₂, and 7 L/min N₂, which produced a peak
144 temperature of ~800 °C in the reaction chamber. The precursor solution
145 containing 12.5 g TEOS, varying amounts of CTAB (CTAB: TEOS molar ratios of
146 0.04~0.22), 400 mL H₂O, 100 mL ethanol, and HCl (to reach pH~2) was sent to the
147 nozzle by a peristaltic pump at a flow rate of 300 mL/h. In the reaction chamber,
148 the precursor solution was atomized into droplets, and the hollow silica particles

149 formed from the droplets. Then, the intermediate product was quenched by a high
150 speed N₂ flow (100 L/min) and finally was collected on a PVDF filter membrane (Ø
151 29.3 cm). Finally, the G-SiO₂ was obtained by calcining the intermediate product at
152 500 °C for 4 hours in air.

153

154 **2.2 L-SiO₂**

155 The material denoted as L-SiO₂ was produced in the liquid phase by a sacrificial
156 template method. The carbon template was synthesized using hydrothermal
157 reaction, where the 60 mL of aqueous glucose solution (0.5~2 M) was placed in a
158 100 mL Teflon-lined stainless-steel autoclave at 180 °C for 8 hours. For fabricating
159 the hollow L-SiO₂, firstly, 0.4 g of the carbon template was uniformly dispersed in
160 100 mL ethanol, 4 mL H₂O, and 4 mL NH₄OH by sonication in a bath sonicator.
161 Then, TEOS was dissolved in 20 mL ethanol and then added into above carbon
162 suspension, with the TEOS concentration varied from 5~60 g/L in the final mixture.
163 The precursor mixture was magnetically stirred at room temperature for 5 hours to
164 deposit the organosilica on the carbon surface. After that, the intermediate
165 product was separated by vacuum filtration, washed with ethanol, and dried
166 overnight. Finally, the L-SiO₂ was obtained by calcining the intermediate product at
167 500 °C for 4 hours in air.

168

169 **3. Fabrication of silica-fiberglass soft ceramic**

170 The hollow silica particles and fiberglass were combined via dispersion in water
171 using a high-shear blender, then collecting them by vacuum filtration and pressing
172 to control the final density of the composite. In details, fiberglass and 300 mL H₂O
173 were placed in a high-shear blender (Eapmic 1108A) and mixed for 10 seconds to
174 break the silica fibers. Then, hollow silica particles were added into the blender,

175 such that the total mass of fiberglass and silica particles was 2 g, with varied
176 hollow silica content of 0 to 80 wt.%. This was blended for 15 seconds to fully mix
177 the fiberglass and silica particle. Next, the resulting suspension was placed in an
178 ultrasonic bath (Kendal HB-S-49MHT) and sonicated at ~42 kHz for 20 minutes.
179 After that, the water was removed by vacuum filtration and the solid material was
180 shaped and collected on the filter paper (Whatman 1001-090, 90 mm diameter).
181 The material density was engineered by thermal compression, in which the wet
182 sample was covered by aluminum foil and compressed into different thickness in a
183 tablet machine (PCH-600CG) and kept at 150 °C for 30 minutes. Finally, it was
184 dried at 70 °C overnight to form the silica-fiberglass soft ceramic.

185

186 **4. Material characterization**

187 The JEOL 2100-F 200 kV field-emission analytical Transmission Electron Microscope
188 (TEM) was used to obtain the high-angle annular dark-field imaging and element
189 distribution (HAADF-STEM elemental mapping). Another TEM (JEOL JEM 2010) and
190 a Cross-Beam Focused Ion Beam-Scanning Electron Microscopy (SEM) Workstation
191 (Carl Zeiss AURIGA) were used to observe the microscopic structure of samples.
192 The fiberglass composition was measured by Energy Dispersive X-ray
193 Spectroscopy (EDS, Oxford Instruments) in the SEM. Powder X-ray diffraction (XRD,
194 Rigaku Ultima IV) was adopted to determine the crystal structure. Nitrogen
195 physisorption analysis (Micromeritics Tri-Star II) was used to characterize pore
196 structure of silica samples. Fourier Transform Infrared spectroscopy (FTIR, Bruker
197 Vertex 70) and Raman spectroscopy (Renishaw InVia) were used to probe the
198 surface groups of silica samples. Thermo-Gravimetric analysis (TGA, TA
199 instruments DSC SDT Q600) was performed to measure the mass loss of
200 intermediate products. The thermal conductivity measurement was performed

201 with a custom laboratory device following the ASTM C518 standard thermal
202 conductivity procedure, and a polystyrene reference sample was used to calibrate
203 the flux sensor provided by Fluxteq company.[49] An infrared thermal camera
204 (Fotric 225) was used to take the infrared images of soft ceramics on a 360 °C hot
205 plate. The mechanical flexibility of the soft ceramics was characterized by a
206 universal MTS testing machine.[49]

207

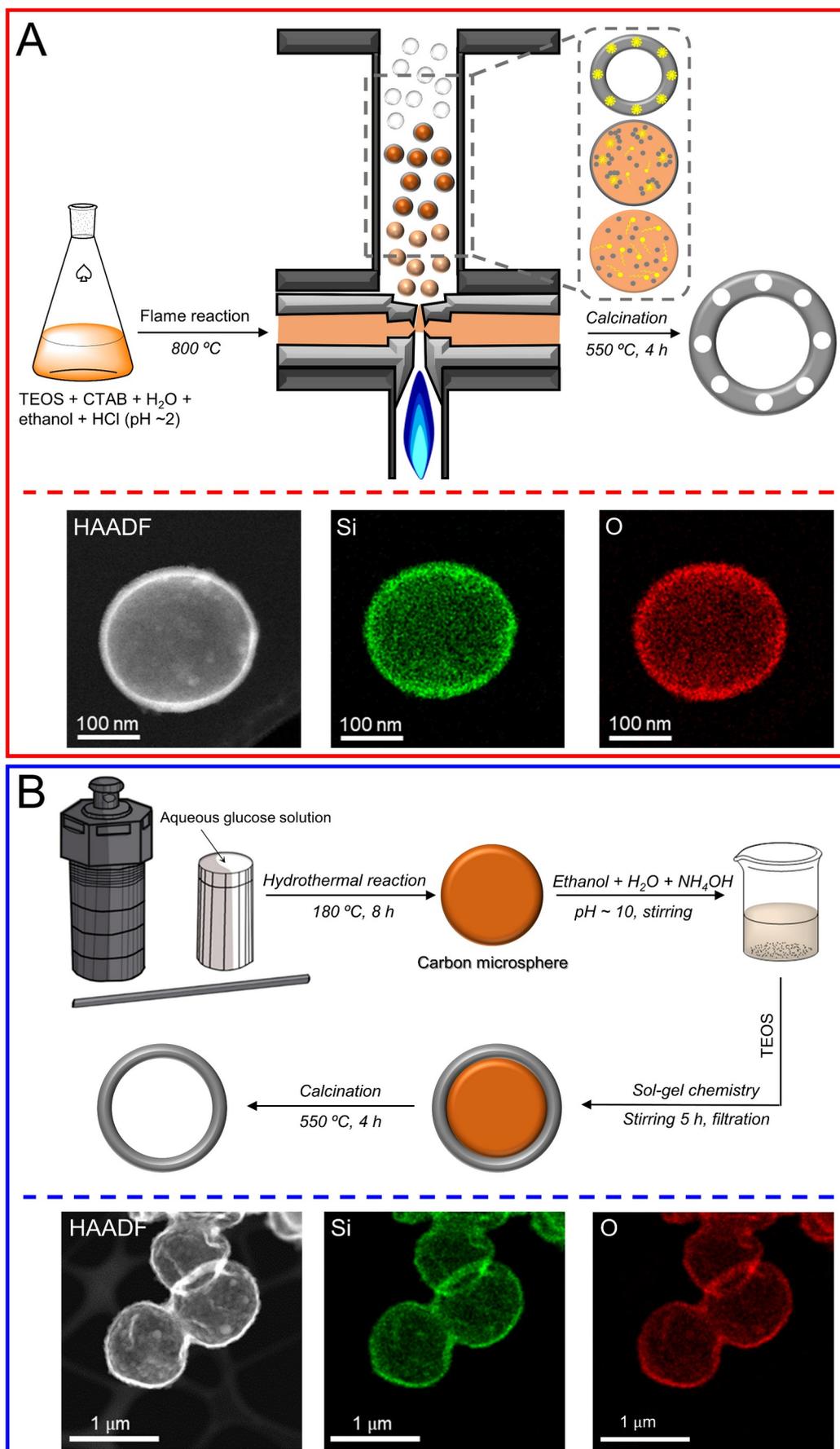
208 **Results and discussion**

209 The hollow G-SiO₂ particle was formed by a droplet-to-particle conversion route in
210 an aerosol reactor, as shown in **Figure 1A**. The TEOS solution was atomized to
211 micro-sized droplets by the sonic-velocity stream of hot combustion product gases.
212 Each droplet produces a single nanoshell inside the reaction chamber. In detail,
213 the droplet evaporation increased TEOS concentration to drive organosilica sol-gel
214 process. Here, the evaporation rate (<0.05s) was much faster than the molecular
215 diffusion rate in the droplet, so the TEOS concentration in the droplet surface
216 region was higher than the center. We added the cation surfactant (CTAB) in the
217 precursor to induce porosity in the final structure. When the CTAB concentration
218 exceeded the critical micelle concentration (CMC) during the evaporation process,
219 it would self-assemble into cylindrical micelles that serve as a soft template for
220 pore formation in the organosilica matrix. Finally, removal of the organics in the
221 intermediate product by calcination generated a hollow and porous silica nanoshell
222 structure. The HAADF-STEM elemental mappings clearly reveals the hollow void
223 and silica composition of G-SiO₂.

224

225 The hollow L-SiO₂ particle was fabricated by a sacrificial template route in the
226 liquid phase, with the hydrothermal carbon as hard-template, as shown in **Figure**

227 **1B.** Glucose molecules underwent dehydration and polymerization in the
228 hydrothermal reaction, forming carbon microspheres.[50] Then, the carbon
229 template was dispersed in a solvent and the TEOS was added into the suspension.
230 In the alkaline environment, organosilica precipitated on the carbon microsphere
231 surface *via* a sol-gel process. Removal of the carbon template and other organics
232 by calcination produced the hollow silica particles. Similarly, the HAADF-STEM
233 elemental mapping clearly shows the hollow void and silica composition of L-SiO₂.



234

235 **Figure 1.** Hollow silica particle formation mechanism and HAADF-STEM element
 236 maps. **A.** G-SiO₂ fabricated in the gas phase and **B.** L-SiO₂ fabricated in the liquid

237 phase.

238 The thermal insulation performance of hollow silica or other aerogels is dependent
239 on multiple factors, such as density, morphology, and porosity. For example, a high
240 porosity with small pore size and the hollow void with thin shell could greatly limit
241 the gas motion, and therefore reduce thermal conductivity. [12, 15] Low density
242 (high porosity) reduces the solid-phase thermal conduction.[51] This research aims
243 to control the key properties of G-SiO₂ and L-SiO₂ by varying synthesis parameters.
244 In general, materials produced from aerosol synthesis methods often suffer from
245 limited control of morphology and structure, along with inhomogeneous size
246 distribution, due to the violent spray pyrolysis reaction and fast particle formation.
247 [24] Fortunately, the density of G-SiO₂ is controllable by adjusting the CTAB: TEOS
248 molar ratio in precursor solution.

249

250 As shown in **Table S1**, upon increasing the CTAB: TEOS molar ratio from 0.04 to
251 0.22, the density of G-SiO₂ first decreased then increased. The lowest density of
252 0.015 g/cm³ was obtained at a CTAB:TEOS molar ratio of 0.08, which also provides
253 the lowest thermal conductivity of 0.023 W/(mK). All four G-SiO₂ samples mainly
254 exhibited a hollow and porous nanoshell morphology (**Figure S2A-D**), although
255 some vesical structures were observed in the G-SiO₂ fabricated with the 0.08
256 CTAB:TEOS molar ratio (**Figure S3A-B**). More detailed characterization results for
257 the optimized G-SiO₂ with the lowest density of 0.015 g/cm³ are shown in **Figure**
258 **S4**. The XRD pattern demonstrated the amorphous phase of G-SiO₂ (**Figure S4A**),
259 in which heat transfer is inhibited by the highly disordered structure resulting in
260 lower thermal conductivity than crystalline materials.[13] The size distribution
261 curve reveals the intrinsic inhomogeneity of the particles generated from such
262 aerosol processes (**Figure S4B**). N₂ sorption measurements in **Figure S4C**
263 showed type IV isotherms, consistent with a mesoporous structure. [52] The BJH

264 adsorption pore size distribution showed narrow pores of 1~5 nm in the wall
265 (**Figure S4D**), which is much smaller than the air molecules mean free path (~68
266 nm at ambient conditions) which limits heat transfer by intermolecular collisions.
267 [53] Additionally, TGA and FTIR analysis (**Figure S4E-F**) of the intermediate
268 product demonstrated that organic components were removed below 550 °C, and
269 only SiO₂ remained after calcination, with a few isolated silanol groups.[54]

270

271 In contrast to the aerosol synthesis, liquid-phase methods often provide easy
272 morphology control. Here, carbon microspheres were first synthesized in the
273 hydrothermal reaction. As shown in **Figure S5**, the initial glucose aqueous
274 concentration had significant effect on carbon average diameter, and relatively
275 small carbon microsphere size was achieved at ~1 M. **Meanwhile, the hollow void**
276 **size of L-SiO₂ depends on the diameter of carbon microsphere, and **Figure S6****
277 **exhibits that the board void size of L-SiO₂ can be achieved from 300 to 2300 nm by**
278 **using different carbon templates. **Figure S7** shows the hollow L-SiO₂ samples**
279 **fabricated with various TEOS concentrations from 5 g/L to 60 g/L, which**
280 **demonstrates that the shell thickness of L-SiO₂ can be controlled by the TEOS**
281 **concentration when carbon amount was fixed. High TEOS concentration often**
282 **generated thicker shell.** In addition, a low TEOS concentration of 5 g/L generated
283 irregular shape, and further increasing TEOS concentration led to a regular and
284 homogeneous hollow nanoshell structure; while a high TEOS concentration of 60 g/
285 L formed undesirable small-size solid particles due to homogenous nucleation in
286 addition to heterogeneous deposition of silica on the carbon template. Detailed
287 properties of L-SiO₂ samples are provided in **Table S2**, including apparent density,
288 mean average diameter, average shell thickness and thermal conductivity. As a
289 typical example, the L-SiO₂ fabricated with 10 g/L TEOS was selected for further

290 characterization and application because of its lowest density and thermal
291 conductivity. The XRD pattern demonstrated its amorphous structure (**Figure**
292 **S8A**), and the size distribution curve reflected its homogeneity (**Figure S8B**). N₂
293 sorption measurements in **Figure S8C** showed type III isotherms, indicating
294 limited porosity, and the BJH adsorption analysis revealed a broad pore size
295 distribution (**Figure S8D**). TGA and Raman analysis (**Figure S8E-F**) demonstrated
296 that the carbon template was removed below 550 °C. Also, Raman analysis of the
297 intermediate product showed a low D band to G band intensity ratio of 0.33,
298 indicating a high graphitic degree of the carbon microsphere.

299

300 We summarize the properties of G-SiO₂, L-SiO₂, and the commercial silica gel C-
301 SiO₂ in **Table 1**, and their TEM and SEM images are shown in **Figure 2**. Both G-
302 SiO₂ and L-SiO₂ provided hollow nanoparticle structures with thin nanoshells. The
303 hollow shell of G-SiO₂ presented a smooth surface with mesopores inside,
304 providing huge specific surface area and pore volume; while the hollow shell of L-
305 SiO₂ consisted of aggregated silica nanoparticles, resulting in a rough surface and
306 limited porosity. On the other hand, L-SiO₂ showed more uniform particle size.
307 Meanwhile, both G-SiO₂ and L-SiO₂ exhibited ultralow density and thermal
308 conductivity due to the small hollow void and thin shell, which are comparable to
309 those of silica aerogels prepared by supercritical drying technology, indicating the
310 great potential of these materials in thermal insulation applications. In contrast,
311 although the commercial silica gel (C-SiO₂) had amorphous structure and exhibited
312 high porosity due to the mesopores between silica nanoparticles (**Figure S9**), the
313 accumulation of solid matter caused the huge particle size in macroscopy,
314 resulting in the high density and thermal conductivity.

Table 1. Material characterizations of silica aerogels

Samples	G-SiO ₂	L-SiO ₂	C-SiO ₂
Crystallinity	amorphous	amorphous	amorphous
BET surface area (m ² g ⁻¹)	665	35	331
Pore volume (cm ³ g ⁻¹)	0.498	0.165	0.813
Average pore size (nm)	2.92	44.8	7.68
Apparent density (g cm ⁻³)	0.015	0.033	0.470
Mean average diameter (nm)	442	383	N.A.
Geometric average diameter (nm)	287	377	N.A.
Average shell thickness (nm)	35.0	36.0	N.A.
Thermal conductivity (W m ⁻¹ K ⁻¹)	0.023	0.025	0.046
N.A. Related data is not available.			

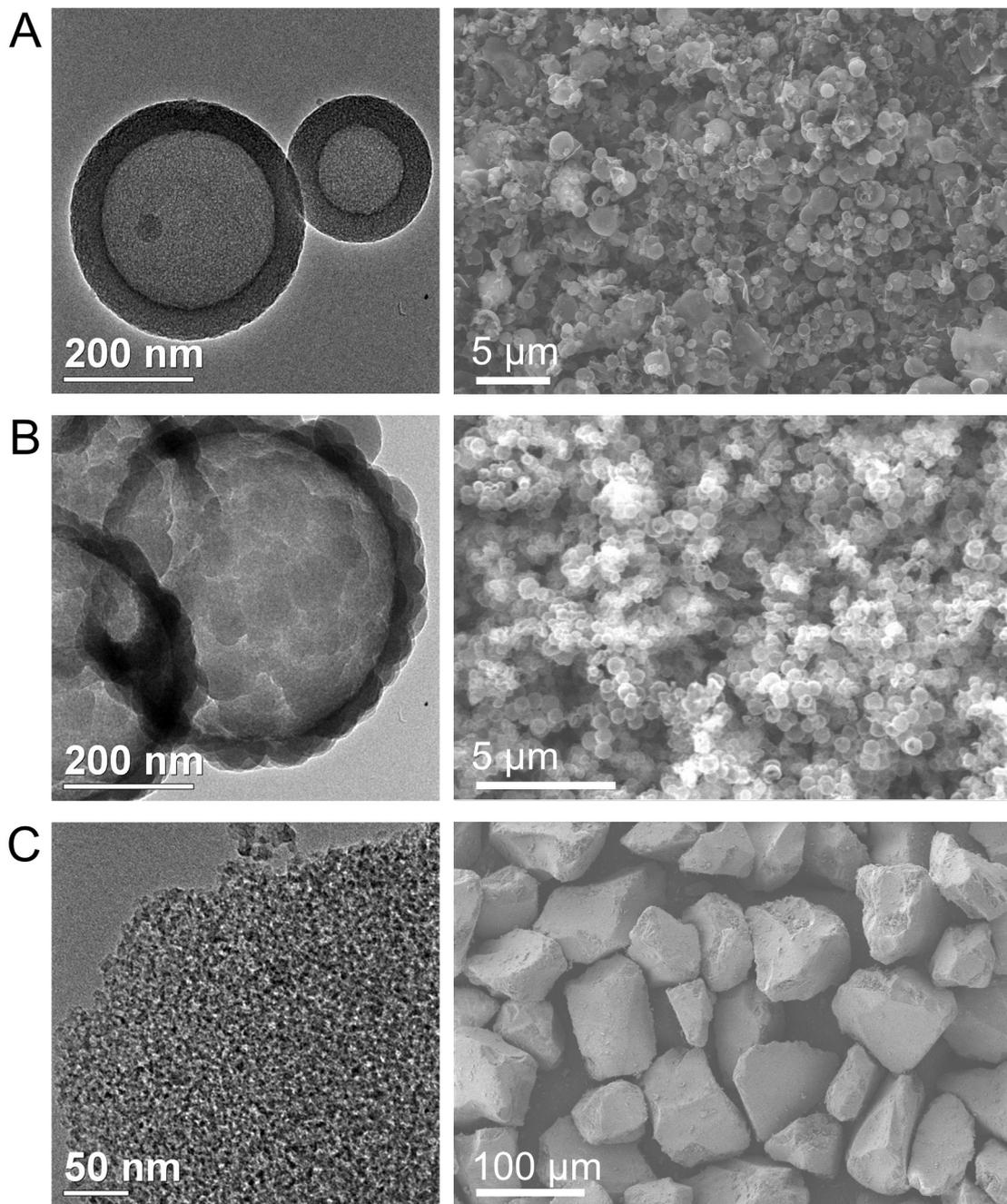


Figure 2. TEM and SEM images of **A.** G-SiO₂, **B.** L-SiO₂, and **C.** C-SiO₂.

315

316

317

318 For practical use of the hollow silica in thermal insulation, the loose particles must
 319 be converted into a bulk material with robust mechanical properties. Fiber
 320 reinforcement is a known strategy to assemble silica aerogel powder and
 321 overcome its brittleness.[55] We further confirmed here that ceramic fiber can be
 322 employed as a scaffold for loading a large amount of hollow silica particles thanks
 323 to its high strength and flexibility, low density, thermal stability, and low cost.

324 **Figure S10** shows the basic information of C-08-F glass microfiber (amorphous
325 structure) adopted in this work, with a nominal specific surface area of 2 m²/g, as
326 well as a nominal fiber diameter of 0.8 μm. As expected, the EDS analysis
327 indicated that the major component of the commercial fiberglass was SiO₂, with a
328 few other elements present (**Figure S10D**).

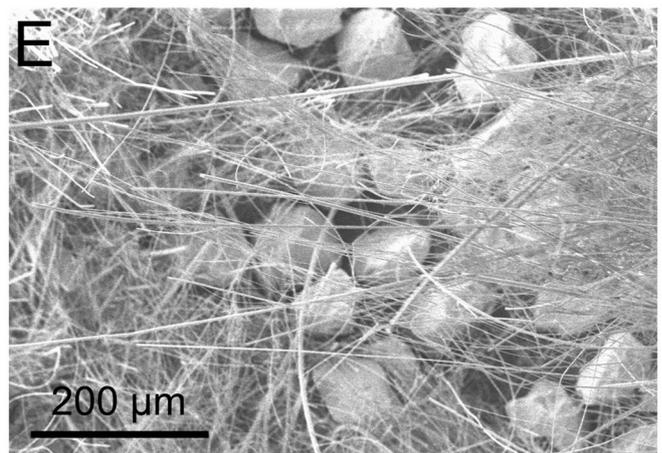
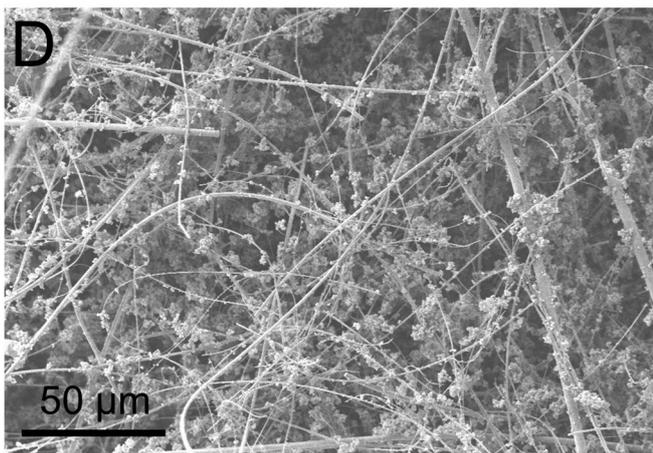
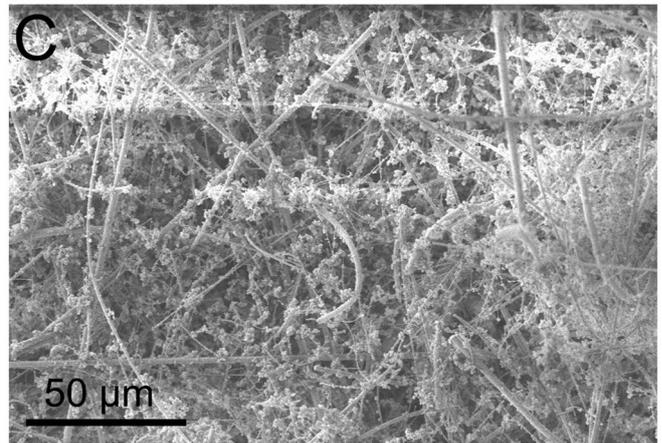
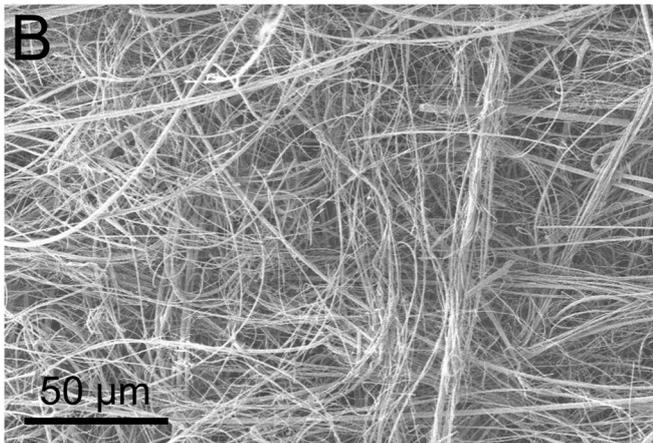
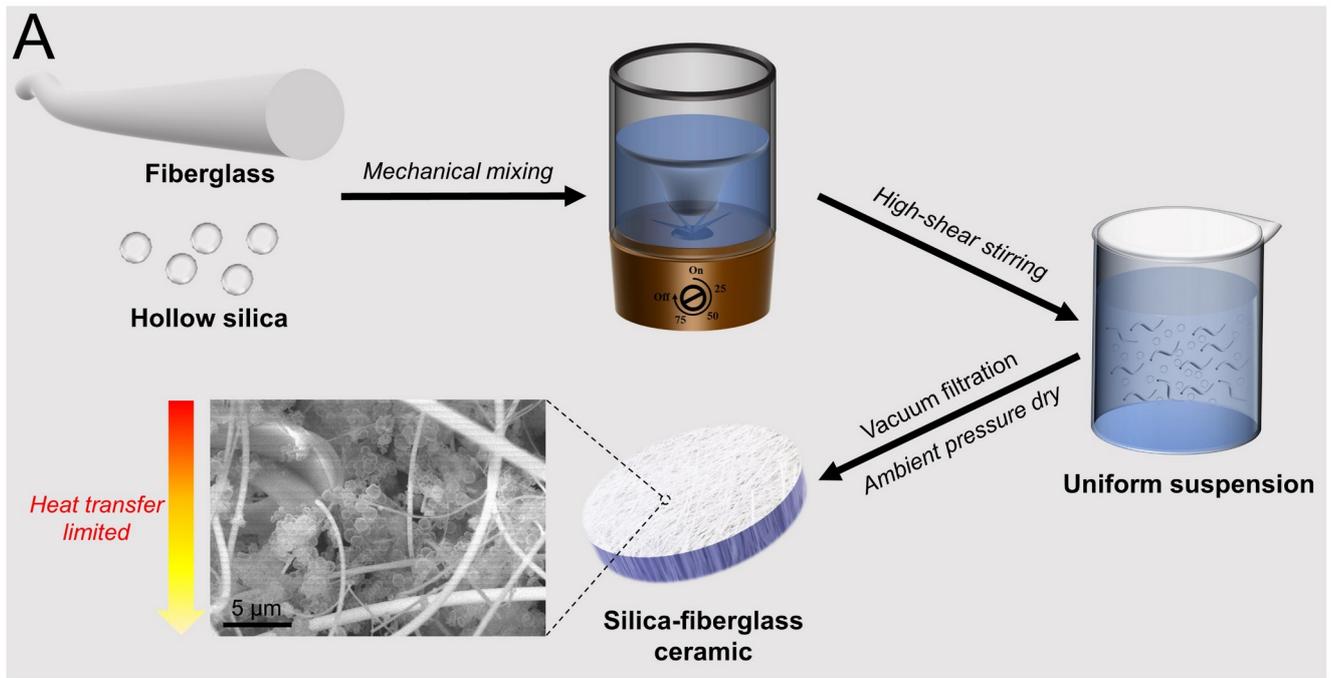
329

330 **Figure 3A** illustrates the mechanical mixing technique employed to produce the
331 hollow silica - fiberglass composite soft ceramic, which produced a promising
332 crosslinked ceramic structure based on intimate contact between hollow silica
333 particles and fiberglass fibers. We employed a simple high-shear blender to disrupt
334 the fiberglass network and simultaneously assemble the hollow silica on the
335 fiberglass matrix. Meanwhile, we used a filtration method, similar to papermaking,
336 to produce the final dried composite, demonstrating the potential for cost-
337 effective, environmentally friendly and scalable production. **No silica particles or
338 fiberglass was wasted in the manufacturing process, which enables to accurate
339 control of the silica to fiberglass ratio in final product.**

340

341 In general, the silica particles serve as a binder to hold the network together, while
342 reducing direct contact between fibers and simultaneously reducing potential gas
343 transport in the composite mat. The fiberglass provided a scaffold for loading and
344 dispersing the hollow silica particles to create a monolithic structure. The
345 microscopic 3D intertwined networks and other detailed information of pure
346 fiberglass were given in **Figure 3B**. The SEM image in **Figure 3C-D** exhibit the
347 morphology of the hollow silica - fiberglass ceramics, demonstrating that both G-
348 SiO₂ and L-SiO₂ could achieve high dispersion and loading on the fiberglass
349 surface. In contrast, the C-SiO₂ failed to disperse well, due to its high density and

350 aggregation (**Figure 3E**). Also, **Figure S11** shows the FTIR spectra of G-SiO₂
351 particle, commercial C-08-F fiberglass, and the fabricated G-SiO₂ - fiberglass
352 composite ceramic. Typically, the peaks below 1200 cm⁻¹ attribute to inorganic
353 bonds, and the peaks at 1416 cm⁻¹ and 1639 cm⁻¹ attribute to the surface -OH
354 groups.[54] There was no new peak appearing in the composite ceramic,
355 suggesting that no chemical bond was formed between hollow silica and
356 fiberglass, and the interactions between hollow silica and fiberglass was physical
357 adsorption.



358

359 **Figure 3. A.** Manufacturing process and microscopic structure of the hollow silica
 360 - fiberglass composite ceramic. SEM images of **B.** commercial fiberglass, **C.** G-SiO₂
 361 - fiberglass composite, **D.** L-SiO₂ - fiberglass composite, and **E.** C-SiO₂ - fiberglass
 362 composite.

363 Thermal transport can occur by convection, radiation and conduction, and the
 364 effective thermal conductivity can be expressed as $k = k_s + k_g + k_c + k_r$, where k_s

365 and k_g are the solid and gaseous heat conduction, respectively; k_c is heat
366 convection which becomes negligible when the void size is smaller than 4 mm; k_r
367 is heat radiation which is proportional to T^3 and can also be ignored at room
368 temperature.[16, 56, 57] We further address how the obtained crosslinked hollow
369 silica - fiberglass structure contributes to reduce thermal conductivity, specifically
370 for the depressed k_s and k_g . As shown in **Figure 4A**, for the fiberglass without
371 hollow silica loading, heat conduction between fibers was smooth. After loading
372 hollow silica particles, with the interrupted void space between fibers, k_g
373 decreased due to the hollow void inside the silica particles and the void space in
374 the fiber network, which obviously increased the air molecules collision frequency.
375 Simultaneously, k_s was also limited because the heat transfer route in the solid
376 phase through the fiber network was interrupted by the hollow silica nanoshell on
377 surface. Such a frequently interrupting and alternating "solid-gas-solid-..." heat
378 transport mechanism leads to high thermal insulation performance of hollow silica
379 - fiberglass ceramics.

380

381 **Figure 4B** shows the thermal conductivity of the nanocomposite insulation with
382 varied silica content. When incorporating 20 wt.% G-SiO₂, the thermal conductivity
383 greatly reduced from 0.038 W/(m K) to 0.025 W/(m K), demonstrating the validity
384 of the proposed thermal insulation mechanism. The lowest thermal conductivity of
385 0.023 W/(m K) was realized at 60 wt.% G-SiO₂ content, and further increasing the
386 G-SiO₂ content to 80 wt.% increased the thermal conductivity. The L-SiO₂-
387 fiberglass ceramic obtained the lowest thermal conductivity of 0.026 W/(m K) at
388 50 wt.% L-SiO₂ content. Both G-SiO₂ - fiberglass and L-SiO₂ - fiberglass ceramics
389 provided better thermal insulation performance than C-SiO₂ - fiberglass ceramic
390 due to their natural low thermal conductivity and the good dispersion on

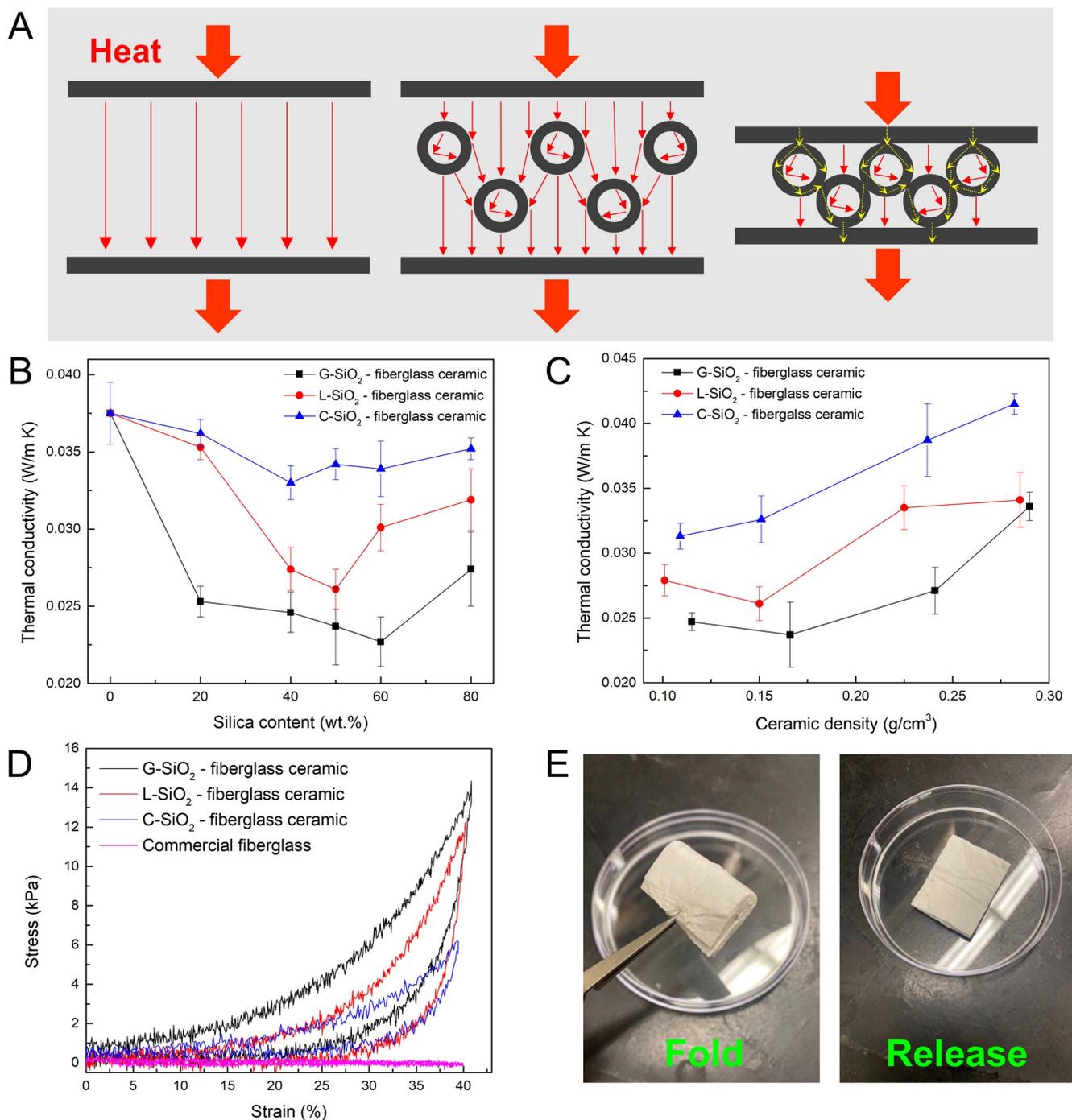
391 fiberglass. It's noticed that even the C-SiO₂ - fiberglass ceramic presented a
392 thermal conductivity of 0.033 W/(m K), which was lower than that of either the
393 fiberglass alone (0.038 W/(m K)) or the C-SiO₂ alone (0.046 W/(m K)), illustrating
394 the generality of the technique applied in this work for manufacturing a class of
395 thermal insulation materials. The thermal conductivity increased upon further
396 increasing the silica content to 80 wt.%, which might be related to the increased
397 density.

398

399 We further studied the relationship between the thermal conductivity and ceramic
400 density with 50 wt.% silica content. The low density was achieved by a shorter
401 filtration time, and the high density was achieved by thermal compression
402 treatment in a tablet machine at 150 °C. As shown in **Figure 4C**, the thermal
403 conductivity exhibited a tendency of first decreasing and then increasing with
404 increasing density. Here, we explained that the ceramic with low density had a
405 large air space for effective heat transfer in gas phase. Slightly increasing the
406 density could reduce the air space and thus limit the air molecules movement to
407 reduce gas thermal conductivity. However, as shown in the third schematic in
408 **Figure 4A**, further increasing the density increased the solid contacts, which
409 introduced new heat transfer routes in the solid phase and caused the thermal
410 conductivity to increase.

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414 **Figure 4.** **A.** Schematic of heat conduction in the hollow silica - fiberglass
 415 **ceramics.** **B.** Thermal conductivity of hollow silica - fiberglass ceramics with varied
 416 silica content. **C.** Thermal conductivity of hollow silica - fiberglass ceramics with
 417 varied ceramic density. **D.** Engineering stress-strain curves of G-SiO₂ - fiberglass,
 418 L-SiO₂ - fiberglass, C-SiO₂ - fiberglass composite ceramics, and commercial
 419 fiberglass with 40% compressive strain. **E.** Ceramic folding to illustrate the
 420 mechanical flexibility of G-SiO₂ - fiberglass soft ceramic.

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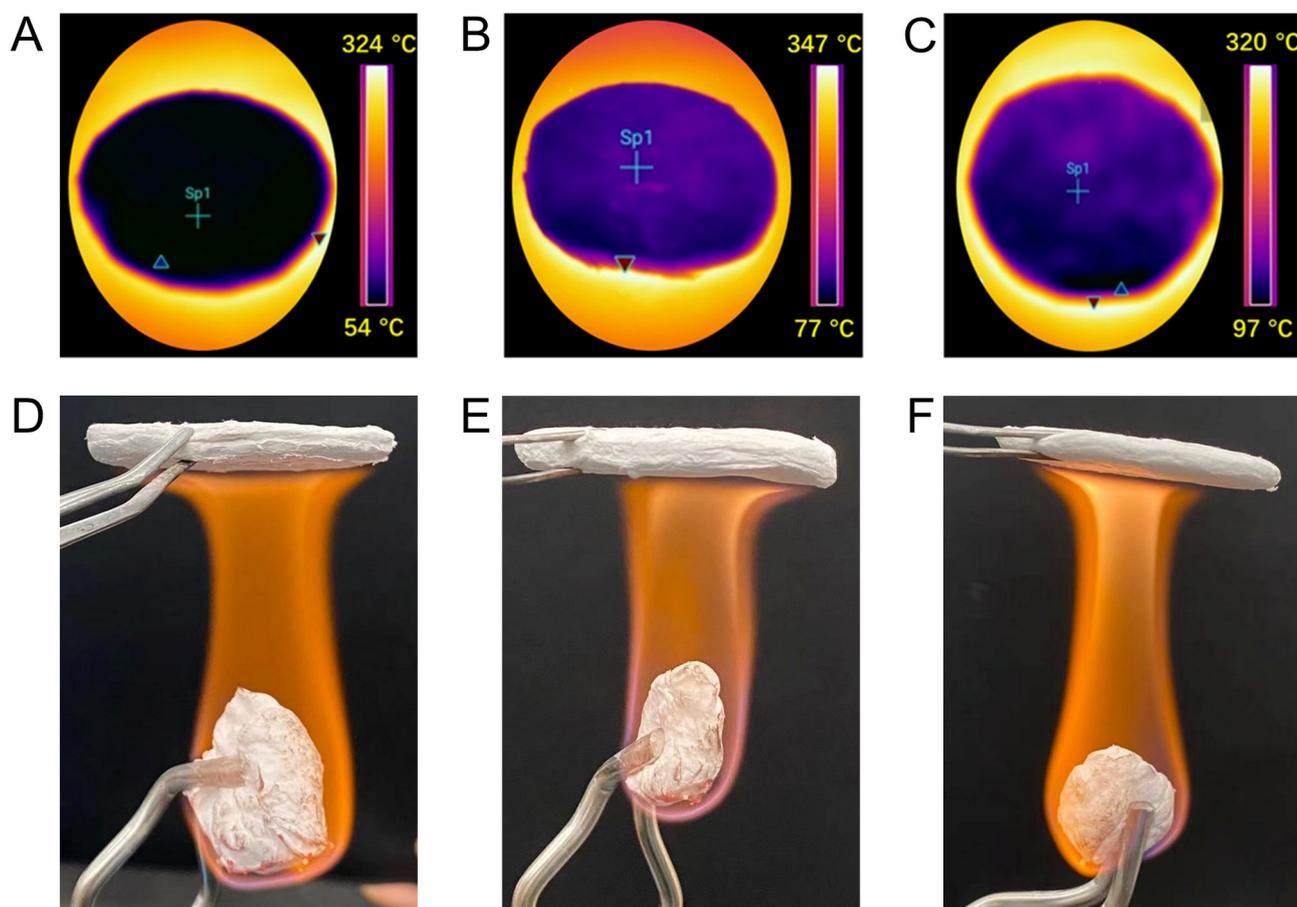
The interactions between hollow silica and fiberglass not only contribute to the

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improved thermal insulation performance, but also the enhanced mechanical

425 properties, overcoming the intrinsically brittle characteristics of aerogel ceramics.
426 After incorporation of hollow silica particles, the interfacial interaction among the
427 fragile and loose state of original commercial fiberglass (**Figure S10B**) was
428 enhanced. The silica particles provided a reinforcing effect on the fiber network,
429 forming a block soft ceramic. To evaluate the elasto-flexibility, we performed the
430 dynamic compression-recovery deformation tests and the correlated stress-strain
431 curves of the soft ceramics, as shown in **Figure 4D**. The loading and unloading
432 processes presented highly nonlinear behavior, and the stress-strain curves
433 showed a closed hysteresis loop with no abrupt changes. These are the features of
434 energy dissipative, elastic, and highly flexible materials.[8, 58] The Young's
435 modulus of the G-SiO₂, L-SiO₂, and C-SiO₂ - fiberglass ceramics were 35 kPa, 30
436 kPa, and 15 kPa, respectively, indicating the robust elasticity of this class of
437 materials. The Young's modulus of the commercial fiberglass, without processing
438 or addition of hollow silica is too low to measure in the same configuration (**Figure**
439 **4C, Figure S10B**). We note that the Young's modulus of G-SiO₂ and L-SiO₂ -
440 fiberglass soft ceramics were much higher than C-SiO₂ - fiberglass ceramics, which
441 we attribute to the good dispersion of the silica particles within the fiber network.
442 The well dispersed hollow silica particles reinforce the fiber scaffold to resist the
443 compression force and enhance the mechanical strength of fabricated soft
444 ceramics. As a typical example, **Figure 4E** illustrates the recoverable bending
445 behavior of the G-SiO₂ - fiberglass soft ceramic, where the flexible ceramic
446 material could be folded and unfolded without obvious structural damage. In
447 addition, representative thermal images of the nanocomposites are provided in
448 **Figure 5A-C**, showing the significant temperature gradient across samples with a
449 thickness of 6 mm. As expected, the ceramics fabricated using G-SiO₂ and L-SiO₂
450 exhibited better thermal insulation property than C-SiO₂, which was in line with the

451 thermal conductivity analysis discussed above. **Figure 5D-F** illustrates the
452 qualitative fire-retardant performance of composite ceramics in contact with an
453 alcohol flame, confirming the potential applications in high temperature thermal
454 insulation and fire protection.



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456 **Figure 5.** Infrared images of **A.** G-SiO₂, **B.** L-SiO₂, and **C.** C-SiO₂ - fiberglass
457 ceramics (6 mm thickness, lowest thermal conductivity) on a 360 °C hot plate at
458 steady state. Optical images to illustrate the fire-retardancy of **D.** G-SiO₂ -
459 fiberglass, **E.** L-SiO₂ - fiberglass and **F.** C-SiO₂ - fiberglass soft ceramics.
460

461 Finally, **Table 2** compares the manufacturing techniques and thermal conductivity
462 of some reported hollow silica thermal insulation materials to evaluate their
463 potential for scale-up and commercialization. As can be seen, for most of the
464 hollow silica materials produced by hard template method with polystyrene
465 microbeads as sacrificial template, although low thermal conductivity close to that
466 of silica aerogels can be realized, the expensive price of polystyrene microbeads

467 (e.g. \$260 for 0.5 g) impedes their practical use. In contrast, the present hollow
468 silica methods obtained similar or better thermal conductivity but adopted low-
469 cost raw materials and fewer manufacturing steps. On the other hand, silica
470 assembly methods include sintering to porous ceramics, and mixing into polymer
471 or fiberglass matrixes.[5] The porous ceramics involve high temperature
472 calcination procedure, and suffer from their stiff and fragile structure. Embedded
473 silica particles into fiber or other matrixes often requires complex fabrication
474 procedures and devices, such as electrospinning and 3D printing, which often face
475 barrier when scale-up, and the polymer matrixes are not capable of high
476 temperature and fire conditions. On the contrary, the high-shear mechanical
477 mixing technique proposed in current study only involves simple blending,
478 filtration, and drying procedures, without any complex devices, energy intensive
479 processing, or organic chemicals required. Meanwhile, the prepared thermal
480 insulation ceramics (or films) in **Table 2** show a broad range of thermal
481 conductivity, in where the thermal conductivity of G-SiO₂ - fiberglass and L-SiO₂ -
482 fiberglass soft ceramic are lower than most of the hollow silica insulation
483 materials, with robust mechanical properties and fire resistance, suggesting that it
484 is a promising method for scalable and low cost production of high performance
485 thermal insulation materials.

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Table 2. Comparison of reported hollow silica thermal insulation materials

Category	Raw material	Fabrication method	K ($W m^{-1} K^{-1}$)	Ref.
Hollow silica particle	Polystyrene microbeads, TEOS, EtOH, H ₂ O, NH ₄ OH	Hard template	0.020	[38]
	Polystyrene microbeads, TEOS, EtOH, H ₂ O, NH ₄ OH	Hard template	0.035	[15]
	Polystyrene microbeads, TEOS, EtOH, H ₂ O, NH ₄ OH	Hard template	0.015	[14]
	CTAB, TEOS, EtOH, H ₂ O, HCl	Flame aerosol process	0.023	This study
	Carbon particles, TEOS, EtOH, H ₂ O, NH ₄ OH	Hard template	0.025	This study
Hollow silica ceramic	Hollow SiO ₂ , acrylamide, ammonium persulfate, ...	Sintering	0.102	[39]
	Hollow SiO ₂ , MTMS, cyclohexane, EtOH, H ₂ O, HCl	Sol-gel process	0.031	[59]
	Hollow glass, TEOS, oxalic acid, EtOH, H ₂ O, DMF, NH ₄ OH	Pressing and sintering; Sol-gel process	0.033	[60]
	TEOS, CTAB, urea, acetic acid, H ₂ O	Sol-gel process; Thermal annealing	0.036	[49]
	Hollow SiO ₂ , H ₂ O	Thermal annealing	0.071	[37]
Hollow silica-polymer composite film	PU, hollow SiO ₂ , EtOH	Surface modification; Solvent evaporation	0.050	[41]
	PU, hollow SiO ₂ , EtOH	Surface modification; Spray coating	0.029	[61]
	PES, hollow SiO ₂ , DMAc	Film coating	0.030	[17]
	PVDF, epoxy, hollow glass,	Spin coating/gravure	0.047	[62]

	NMP	printing		
	Silicone rubber, hollow SiO ₂	Casting; polymerization	0.149	[42]
	PAN, hollow SiO ₂ , DMF	Electrospinning	0.016	[47]
	PVP, PVA, hollow SiO ₂ , NH ₄ OH, ...	Electrospinning	0.023	[46]
	Fiberglass, PU, hollow glass	Coating	0.115	[63]
Hollow silica-fiberglass composite ceramic	Fiberglass, hollow glass, nano-SiO ₂ , sepiolite fiber	Mechanical mixing; Solvent evaporation	0.050	[64]
	Fiberglass, Hollow L-SiO ₂ , H ₂ O	Mechanical mixing	0.026	This study
	Fiberglass, Hollow G-SiO ₂ , H ₂ O	Mechanical mixing	0.023	This study

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505 Conclusions

506 In summary, we present two facile routes to produce hollow silica thermal
507 insulation materials in both gas-phase and liquid-phase, which provide superior
508 performance attributes such as low density, high porosity, and low thermal
509 conductivity. Furthermore, we present a high shear mechanical mixing and
510 filtration method for fabrication of hollow silica - fiberglass composite soft
511 ceramics. Both the thermal insulation and mechanical performance could be
512 enhanced by the crosslinked network structure, demonstrating a low thermal
513 conductivity of 0.023 W/(m K) and robust elasto-flexibility. This soft ceramic
514 manufacturing technology can be extended to other aerogel-fiber systems as well
515 to broaden their applications, potentially enabling scalable, low-cost, and
516 environmentally friendly fabrication of energy saving and thermal protection
517 materials.

518

519 **Conflicts of interest**

520 The authors have no conflicts to declare.

521

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